

# tof update

*W.J. Llope  
STAR Analysis Mtg  
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# pVPD

run-2

single-range ADC readout  
auau central resn  $\sim 24\text{ps}$

run-3

dual range ADC readout (6:1)  
dAu minbias resn  $\sim 85\text{ps}$   
pp minbias resn  $\sim 140\text{ps}$

run-4

dual range ADC readout (20?:1)  
new base-plate design (w/ scheblein & brown)

continuing its slow march downstream...  
now straddling cross-beam, another  $\sim 5''$

otherwise no major changes for run-4...

expect good performance....

pVPD east in run-2 (view S)



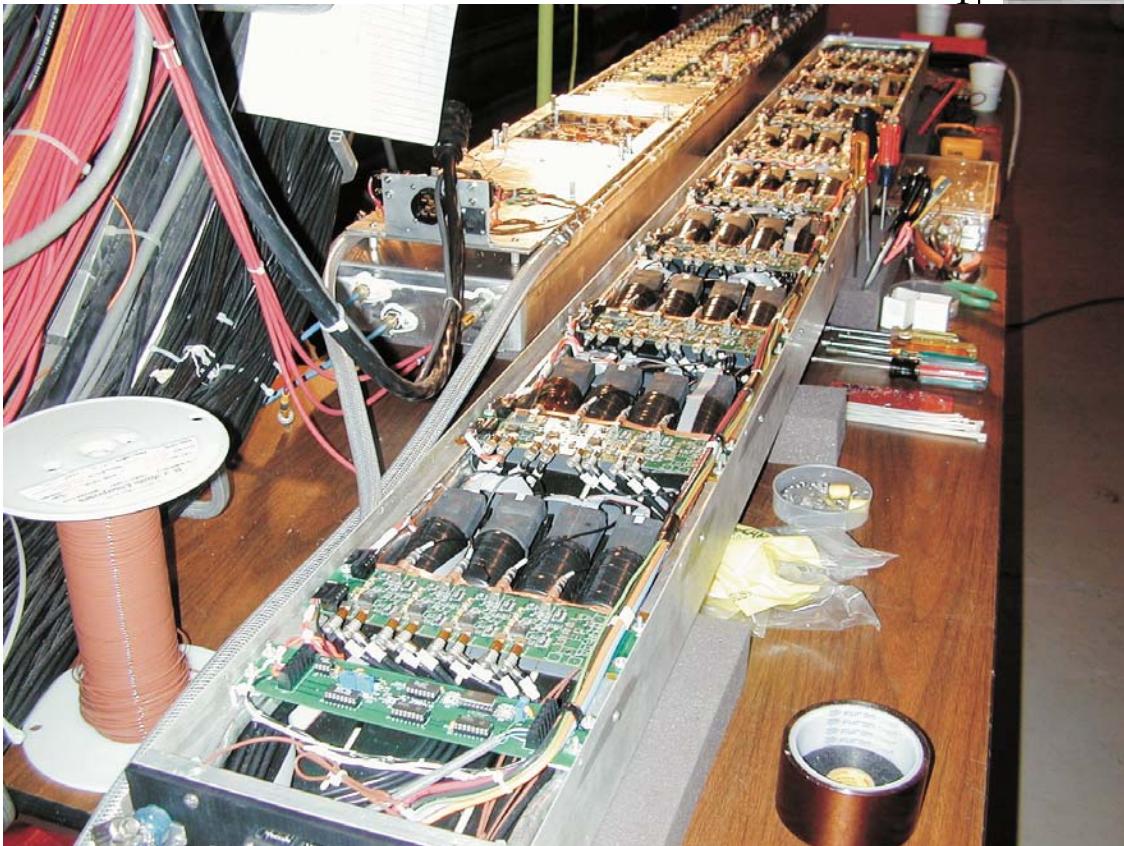
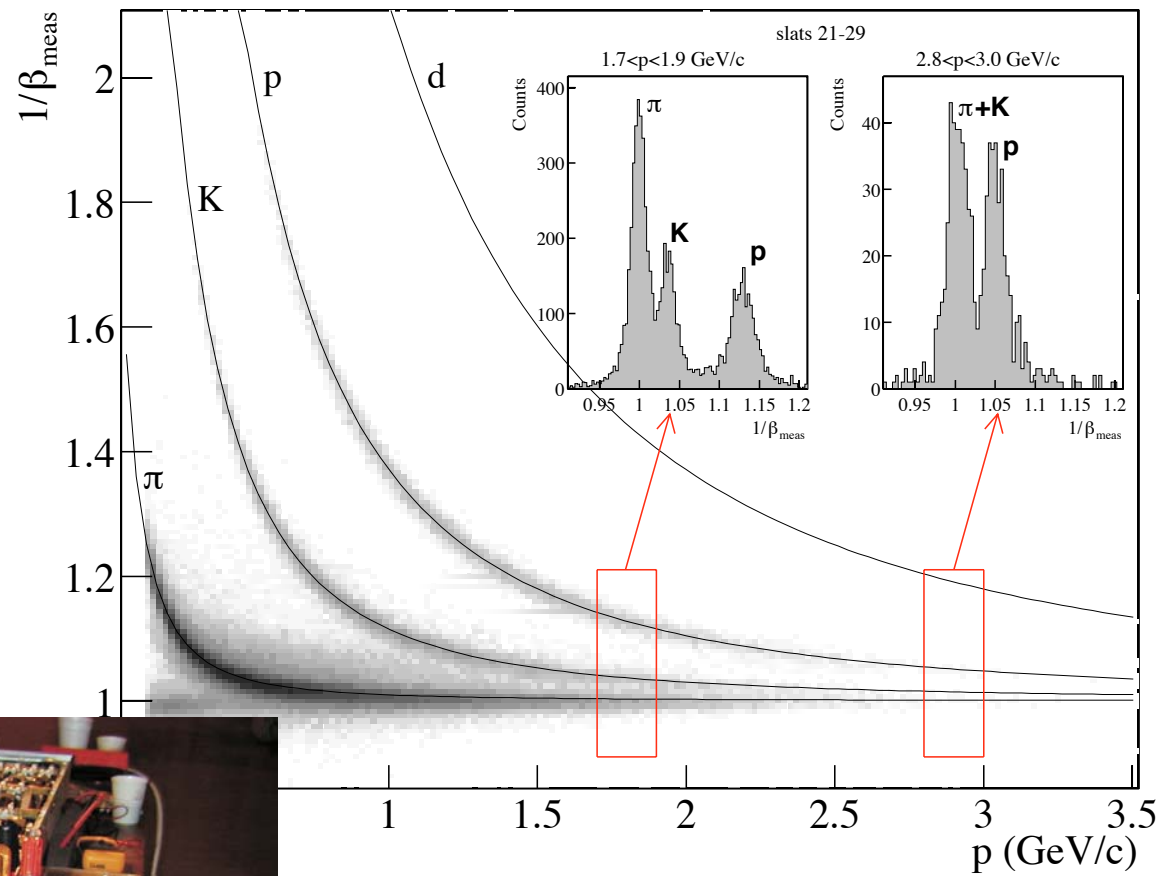
pVPD east for run-4 (view NW)



# TOFp

third run, again no major changes planned  
41 slats,  $\Delta\eta \sim 0.9$

run-2 auau central,  $\sim 2$  hits/unit- $\eta$ /event



calibrations code done

embedding/efficiencies still a WIP...  
run-2 auau central ( $\sim 1.8$ M matches)  
run-3 dau minbias ( $\sim 0.48$ M matches)

tray now under maintenance in WAH...

will move 1 slot CW to sector 20 center

NIm paper accepted



## TOFr (run-3)

28 MRPCs on 2 HV busses  
6 F/T plates close the box & separate FEE layer  
read out 72 chs into camac via TOFp DAQ  
slewing by (amplified) ADC

several calibrations and efficiency simulations exist

stop resn  $\sim 85$  ps in dAu

pT PRL...

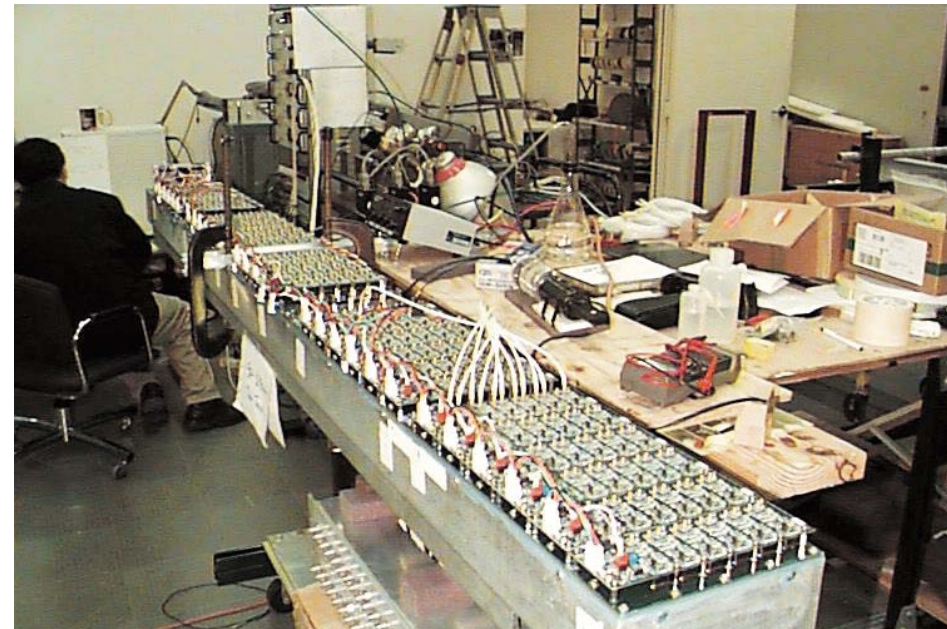
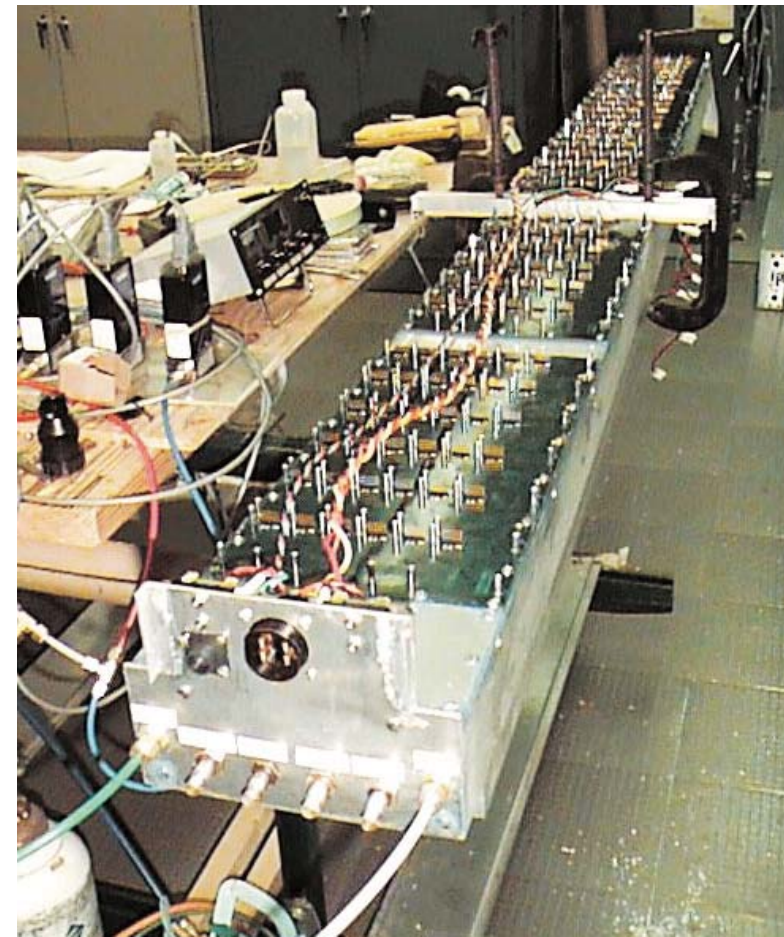
being referee-reviewed

major boost to TOF proposal

electron,  $K^*$ , etc analyses in advanced stages too!

working toward common “match tree” for  
TOFr and TOFp

simple/consistent application of efficiency #s  
comparison of different calibration strategies





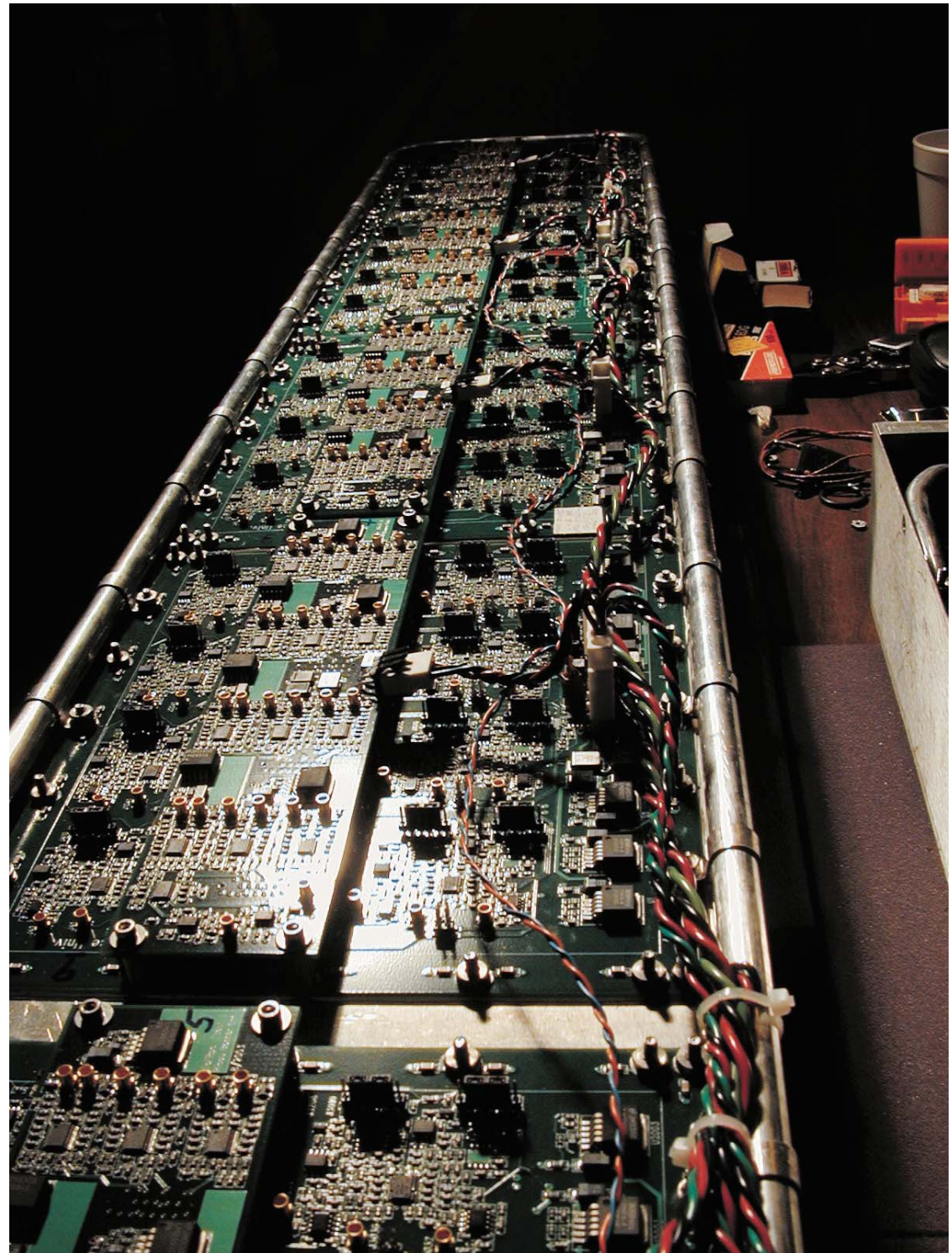
## TOFr' (run-4)

24 MRPCs on 1 HV bus  
the FEEp layer also closes the box ("TFEEp")  
TTST layer generates camac inputs...  
read out 72 chs into camac via TOFp DAQ  
slewing again by (amplified) ADC

includes 20 MRPCs from TOFr plus  
4 new MRPCs (USTC&Tsinghua)

1. vastly simpler/saner mechanical design  
shoe-box style (no rails)  
PEM studs (no welding)  
PEM nuts (no tapping)  
welded feet (fewer holes in box)
2. read out 6 new TDC signals for ToT  
3 variants (1/TFEEp), 2 chs each  
compare slewing corrections  
ToT is default plan for TOF
3. first realistic attempt at  
integrating Jalepeno (HPTDC) w/  
pVPD, DAQ, & TRG.

TFEEp radiate heat into box, heating the gas  
higher noise rates and HV currents  
TOFp-style cooling loop added  
thermocouples diverted from TOFp



("pigtail" signal cables not shown)



TOFp (run-4)

TOFr' (run-4)

PMT/base

FEE

cooling loop

FEE/Thresh

JIP

TFEEp

TTST

cooling loop



new effort to add 48  
more chs into tofp daq  
new cables  
new rack&cooling  
new crates  
new NPS  
rev. software  
12 MRPCs → 20